

## REMARKS/ARGUMENTS

The Examiner is thanked for the insightful interview with Patent Agent Earle Jennings on Sept. 22, 2005. The central points of that interview are summarized from the Applicant's perspective in the following remarks.

**Claim 1** stands rejected as being anticipated by Applicant Admitted Prior Art under 35 USC 102(a). The Applicant respectfully disagrees with this rejection. The Examiner contended that the combination of prior art flex interconnection circuits 220 + 224 of Figures 1 and 2 as forming a flex interconnection circuit on an "inherent" substrate to provide the elements of the Claim. In the interview Mr. Jennings and the Examiner realized that to include the MR read-write head bonding site requires the use of 210 as well. It was agreed that this Claim as amended does call out a structure not found in the Applicant Admitted Prior Art. The Applicant respectfully requests that the Examiner remove this rejection of Claim 1.

**Claims 2 to 6** are dependent upon Claim 1. The Applicant finds the use of the single flex interconnection circuit is not disclosed nor suggested in the cited prior art, whether taken individually or collectively. The Applicant respectfully requests that the Examiner remove the rejection of these Claims, and place them in condition for allowance.

If there are further issues the Examiner wishes to discuss, please contact either Earle Jennings or Gregory Smith at (510) 742-7417.

Very respectfully submitted,

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